# **Amplifier Transistors**

**PNP Silicon** 



### **ON Semiconductor**<sup>™</sup>

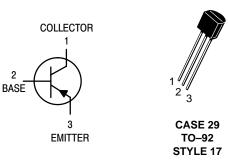
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### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BC556 BC557 BC558	VCEO	-65 -45 -30	Vdc
Collector-Base Voltage BC556 BC557 BC558	V <sub>СВО</sub>	80 50 30	Vdc
Emitter-Base Voltage	VEBO	-5.0	Vdc
Collector Current – Continuous – Peak	IC ICM	-100 -200	mAdc
Base Current – Peak	I <sub>BM</sub>	-200	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	625 5.0	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	–55 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta}$ JA	200	°C/W
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	83.3	°C/W



### ORDERING INFORMATION

Device	Package	Shipping
BC556B	TO-92	5000 Units/Box
BC556BRL1	TO-92	2000/Tape & Reel
BC556BZL1	TO-92	2000/Ammo Pack
BC557	TO-92	5000 Units/Box
BC557ZL1	TO-92	2000/Ammo Pack
BC557A	TO-92	5000 Units/Box
BC557AZL1	TO-92	2000/Ammo Pack
BC557B	TO-92	5000 Units/Box
BC557BRL1	TO-92	2000/Tape & Reel
BC557BZL1	TO-92	2000/Ammo Pack
BC557C	TO-92	5000 Units/Box
BC557CZL1	TO-92	2000/Ammo Pack
BC558B	TO-92	5000 Units/Box
BC558BRL	TO-92	2000/Tape & Reel
BC558BRL1	TO-92	2000/Tape & Reel
BC558BZL1	TO-92	2000/Ammo Pack
BC558C	TO-92	5000 Units/Box
BC558CRL1	TO-92	2000/Tape & Reel
BC558ZL1	TO-92	2000/Ammo Pack
BC558CZL1	TO-92	2000/Ammo Pack

### BC556B, BC557, A, B, C, BC558B, C

#### Characteristic Symbol Min Тур Max Unit **OFF CHARACTERISTICS** Collector-Emitter Breakdown Voltage V(BR)CEO V BC556 -65 $(I_{C} = -2.0 \text{ mAdc}, I_{B} = 0)$ \_ \_ BC557 -45 \_ \_ BC558 -30 \_ \_ V Collector-Base Breakdown Voltage V(BR)CBO $(I_{C} = -100 \ \mu Adc)$ BC556 -80 \_ \_ BC557 -50 \_ \_ BC558 -30 \_ \_ Emitter-Base Breakdown Voltage V(BR)EBO V BC556 -5.0 $(I_E = -100 \ \mu Adc, I_C = 0)$ \_ \_ -5.0 BC557 \_ \_ BC558 -5.0 \_ \_ Collector–Emitter Leakage Current ICES -100 $(V_{CES} = -40 V)$ BC556 -2.0 nΑ - $(V_{CES} = -20 V)$ -100 BC557 \_ -2.0 BC558 \_ -2.0 -100 μΑ $(V_{CES} = -20 \text{ V}, \text{ T}_{A} = 125^{\circ}\text{C})$ BC556 \_ -4.0 \_ BC557 \_ \_ -4.0 BC558 \_ \_ -4.0

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

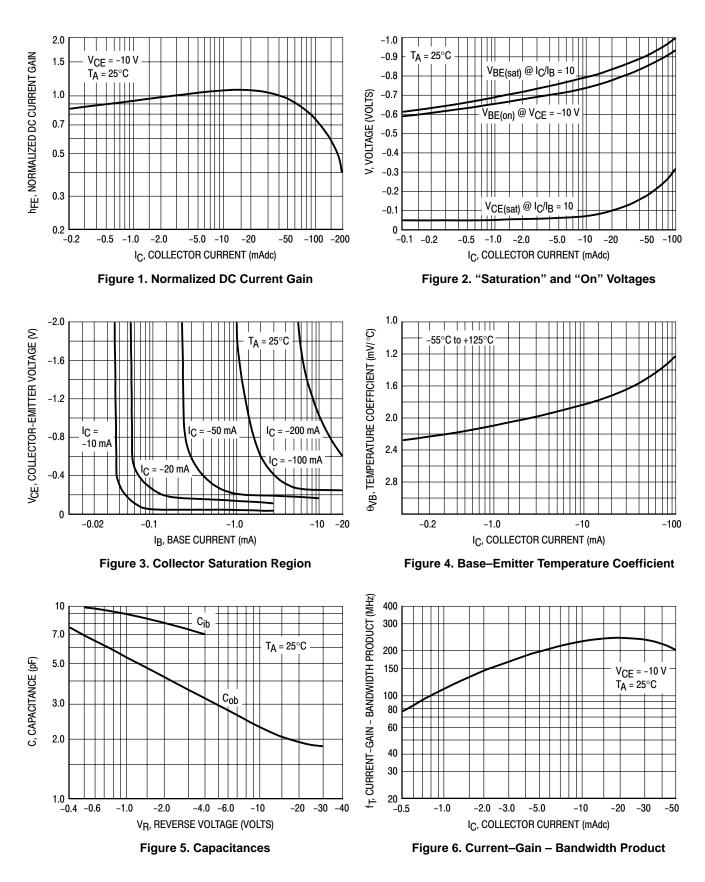
### BC556B, BC557, A, B, C, BC558B, C

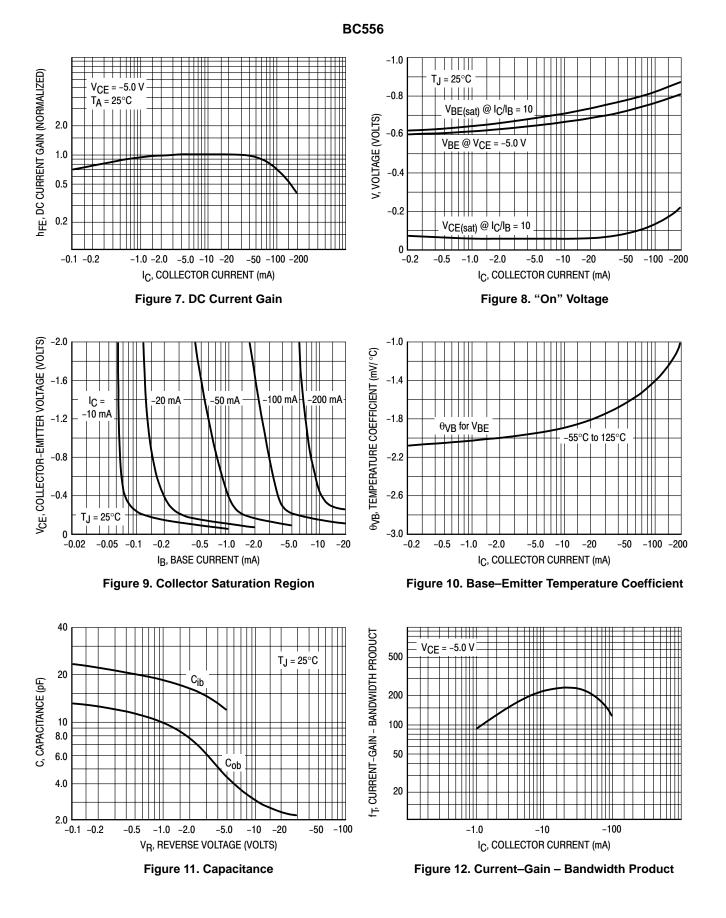
### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS					I	
DC Current Gain (I <sub>C</sub> = $-10 \ \mu$ Adc, V <sub>CE</sub> = $-5.0 \ V$ ) (I <sub>C</sub> = $-2.0 \ m$ Adc, V <sub>CE</sub> = $-5.0 \ V$ )	A Series Device B Series Devices C Series Devices BC557	hFE	- - - 120	90 150 270	- - - 800	-
$(I_{C} = -100 \text{ mAdc}, V_{CE} = -5.0 \text{ V})$	A Series Device B Series Devices C Series Devices A Series Device B Series Devices C Series Devices		120 180 420 - -	170 290 500 120 180 300	220 460 800 - -	
Collector–Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}$ , $I_B = -0.5 \text{ mAdc}$ ) ( $I_C = -10 \text{ mAdc}$ , $I_B = \text{see Note 1}$ ) ( $I_C = -100 \text{ mAdc}$ , $I_B = -5.0 \text{ mAdc}$ )		VCE(sat)	- - -	-0.075 -0.3 -0.25	-0.3 -0.6 -0.65	V
Base–Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -0.5 \text{ mAdc}$ ) ( $I_C = -100 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$ )		V <sub>BE(sat)</sub>	-	-0.7 -1.0	-	V
Base–Emitter On Voltage ( $I_C = -2.0 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ ) ( $I_C = -10 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ )		V <sub>BE(on)</sub>	-0.55 -	-0.62 -0.7	-0.7 -0.82	V
SMALL-SIGNAL CHARACTERISTICS						
Current–Gain – Bandwidth Product ( $I_C = -10$ mA, $V_{CE} = -5.0$ V, f = 100 MHz)	BC556 BC557 BC558	fΤ	- - -	280 320 360	- - -	MHz
Output Capacitance $(V_{CB} = -10 \text{ V}, I_C = 0, f = 1.0 \text{ MHz})$		C <sub>ob</sub>	-	3.0	6.0	pF
Noise Figure (I <sub>C</sub> = $-0.2$ mAdc, V <sub>CE</sub> = $-5.0$ V, R <sub>S</sub> = $2.0$ k $\Omega$ , f = $1.0$ kHz, $\Delta$ f = $200$ Hz)	BC556 BC557 BC558	NF		2.0 2.0 2.0	10 10 10	dB
Small–Signal Current Gain (I <sub>C</sub> = –2.0 mAdc, V <sub>CE</sub> = 5.0 V, f = 1.0 kHz)	BC557 A Series Device B Series Devices C Series Devices	h <sub>fe</sub>	125 125 240 450	_ _ _ _	900 260 500 900	-

Note 1:  $I_C = -10$  mAdc on the constant base current characteristics, which yields the point  $I_C = -11$  mAdc,  $V_{CE} = -1.0$  V.

BC557/BC558





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BC556B, BC557, A, B, C, BC558B, C

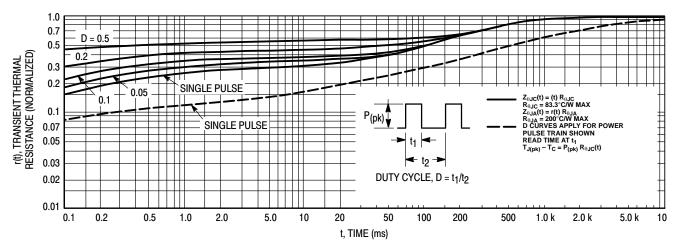


Figure 13. Thermal Response

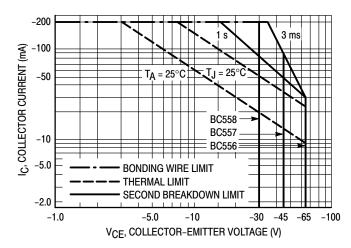


Figure 14. Active Region – Safe Operating Area

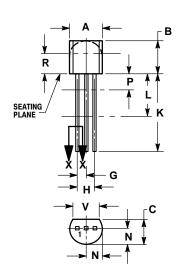
The safe operating area curves indicate  $I_C-V_{CE}$  limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 14 is based upon  $T_{J(pk)} = 150^{\circ}$ C;  $T_{C}$  or  $T_{A}$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}$ C.  $T_{J(pk)}$  may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

### BC556B, BC557, A, B, C, BC558B, C

### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL** 





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
C	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
Κ	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.04	2.66	
Ρ		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 17: PIN 1. COLLECTOR 2. BASE 3. EMITTER

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